

07-24-2000

FORM PTO-1596
1-31-92U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

DOCKET NO.: 2695-036

101412267

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereto:

1. Name of conveying party(ies):

- 1) Syunichi OHNO
2) Masahiko YAMAGISHI

6-29-00

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: January 22, 1999

2. Name and address of receiving party(ies):

Name: TAIYO YUDEN CO., LTD.

Internal Address:

Street Address:

6-20, Ueno 6-chome
Taito-ku, Tokyo 110-0005, JAPAN

City: _____ State/Country: _____ ZIP: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s).

09/240,699 filed February 2, 1999

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: LOWE HAUPTMAN GOPSTEIN GILMAN & BERNER

Internal Address:

Street Address: 1700 Diagonal Road, Suite 310City: AlexandriaState: VAZIP: 223146. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41) \$40.00☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

07/21/2000 DNGUYEN 00000173 08240699

01 FC:581

40.00 DP

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Allan M. Lowe Reg. No. 19,641

Name and Registration No. of Person Signing

Signature

June 29, 2000

Date

Total number of pages comprising cover sheet: 1

CMB No. 0851-0011 (exp. 4/94)

PATENT
REEL: 010926 FRAME: 0718

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) Syunichi OHNO
 (2) Masahiko YAMAGISHI
 (3) _____

(4) _____
 (5) _____
 (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

TAIYO YUDEN CO., LTD.
16-20, Ueno 6-chome,
Taito-ku, Tokyo 110-0005 JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

MULTILAYER ELECTRONIC COMPONENT AND MANUFACTURING METHOD THEREFOR

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

1) *Syunichi Ohno*
 Name: Syunichi OHNO
 2) *Masahiko Yamagishi*
 Name: Masahiko YAMAGISHI
 3) _____
 Name: _____
 4) _____
 Name: _____
 5) _____
 Name: _____
 6) _____
 Name: _____

DATE SIGNED

1999. 1. 22
1999. 1. 22

